



9-19-05

IFW

Express Mail No. EV 346 793 945 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Eric NEYRET et al.

Confirmation No. 6832

Application No.: 10/671,813

Group Art Unit: 2814

Filing Date: September 25, 2003

Examiner: Dilinh P. Nguyen

For: METHOD FOR MINIMIZING SLIP LINE
FAULTS ON A SEMICONDUCTOR WAFER
SURFACE

Attorney Docket No.: 4717-7800

AMENDMENT AND RESPONSE TO RESTRICTION

Mail Stop AMENDMENT

Commissioner for Patents

P.O. Box 1450

Alexandria, Virginia 22313-1450

Sir:

In response to the office action dated September 12, 2005, please enter the following amendments and comments into the file of this application.

Amendments to the claims are reflected in the complete listing of all claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.

No fee is believed to be due for this response. Please charge any required fees to Winston Strawn LLP Deposit Account No. 50-1814.